

## N-沟道功率 MOS 管/ N-CHANNEL POWER MOSFET

SIF9N20D

●特点：导通电阻低 开关速度快 输入阻抗高 符合RoHS规范

●FEATURES: ■LOW ON-RESISTANCE ■FAST SWITCHING ■HIGH INPUT RESISTANCE

■RoHS COMPLIANT

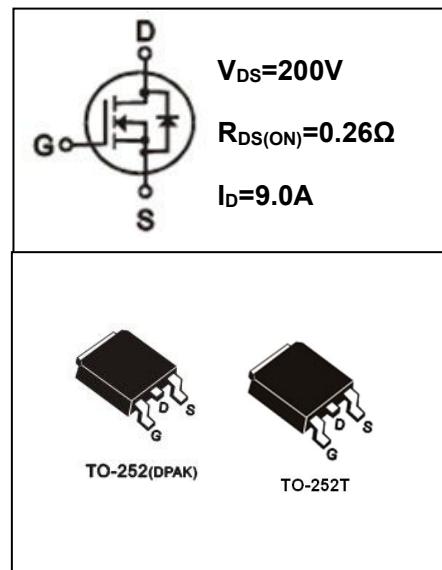
●应用：照明 不间断电源 开关电源 AC-DC 转换电路

●APPLICATION: ■LIGHTING ■UNINTERRUPTED POWER SUPPLY ■SWITCH MODE POWER SUPPLY  
■ AC-DC CONVERSION CIRCUIT

●最大额定值 (Tc=25°C)

●Absolute Maximum Ratings (Tc=25°C) TO-252/252T

参数 PARAMETER	符号 SYMBOL	额定值 VALUE	单位 UNIT
漏-源电压 Drain-source Voltage	V <sub>DS</sub>	200	V
栅-源电压 gate-source Voltage	V <sub>GS</sub>	±30	V
漏极电流 Continuous Drain Current TC=25°C	I <sub>D</sub>	9	A
漏极电流 Continuous Drain Current TC=100°C	I <sub>D</sub>	4.5	A
最大脉冲电流 Drain Current -Pulsed ①	I <sub>DM</sub>	36	A
耗散功率 Power Dissipation	P <sub>tot</sub>	40	W
最高结温 Junction Temperature	T <sub>j</sub>	150	°C
存储温度 Storage Temperature	T <sub>STG</sub>	-55-150	°C
单脉冲雪崩能量 Single Pulse Avalanche Energy ②	E <sub>AS</sub>	61	mJ



●电特性 (Tc=25°C)

●Electronic Characteristics (Tc=25°C)

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
漏-源击穿电压 Drain-source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	200			V
击穿电压温度系数 Breakdown Voltage Temperature Coefficient	Δ BV <sub>DSS</sub> / Δ T <sub>j</sub>	I <sub>D</sub> =250μA, Referenced to 25°C		0.6		V/°C
栅极开启电压 Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA	2.0		4.0	V
漏-源漏电流 Drain-source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =200V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C			25	μA
		V <sub>DS</sub> =200V, V <sub>GS</sub> =0V, T <sub>j</sub> =125°C			250	μA
跨导 Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =4.5A ③	1.6			S

●订单信息/ORDERING INFORMATION:

包装形式/PACKING	订货编码/ORDERING CODE	
	普通塑封料/ Normal Package Material	无卤塑封料/Halogen Free
TO-252(T) 条管装 TUBE PACKING	SIF9N20D TO-252(T)-TU	SIF9N20D TO-252(T)-TU-HF
TO-252(T) 编带装/TAPE & REEL PACKING	SIF9N20D TO-252(T)-TR	SIF9N20D TO-252(T)-TR-HF

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参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
栅极漏电流 Gate-body Leakage Current ( $V_{DS} = 0$ )	$I_{GSS}$	$V_{GS} = \pm 30V$			$\pm 100$	nA
漏-源导通电阻 Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 4.5A$ ③		0.26	0.3	$\Omega$
输入电容 Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 25V$ $F = 1.0MHz$		605.5		pF
关断延迟 Turn -Off Delay Time	$T_{d(off)}$	$V_{DD} = 250V, I_D = 9A$ $R_G = 3.5\Omega, R_D = 25\Omega$ ③		70		ns
栅极电荷 Total Gate Charge	$Q_g$	$I_D = 9.5A, V_{DS} = 100V$ $V_{GS} = 10V$ ③		15.5		nC
栅源电荷 Gate-to-Source Charge	$Q_{gs}$			2.9		nC
栅漏电荷 Gate-to-Drain Charge	$Q_{gd}$			5.5		nC
二极管正向电流 Continuous Diode Forward Current	$I_s$				9.0	A
二极管正向压降 Diode Forward Voltage	$V_{SD}$	$T_j = 25^\circ C, I_s = 9A$ $V_{GS} = 0V$ ③			1.0	V
反向恢复时间 Reverse Recovery Time	$t_{rr}$	$T_j = 25^\circ C, I_f = 9A$ $di/dt = 100A/\mu s$ ③			160	ns
反向恢复电荷 Reverse Recovery Charge	$Q_{rr}$			1.0		$\mu C$

●热特性

●Thermal Characteristics

参数 PARAMETER	符号 SYMBOL	最大值 MAX	单位 UNIT
热阻结-壳 Thermal Resistance Junction-case	$R_{thJC}$	3.25	$^\circ C/W$
热阻结-环境 Thermal Resistance Junction-ambient	$R_{thJA}$	62.5	$^\circ C/W$

注释(Notes):

① 脉冲宽度: 以最高结温为限制

Repetitive rating: Pulse width limited by maximum junction temperature

② 初始结温= $25^\circ C$ ,  $V_{DD} = 50V$ ,  $L = 3.5 mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 7.0A$

Starting  $T_j = 25^\circ C$ ,  $V_{DD} = 50V$ ,  $L = 3.5 mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 7.0A$

③ 脉冲测试: 脉冲宽度 $\leq 300\mu s$ , 占空比 $\leq 2\%$

Pulse Test : Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$

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### ● 特性曲线

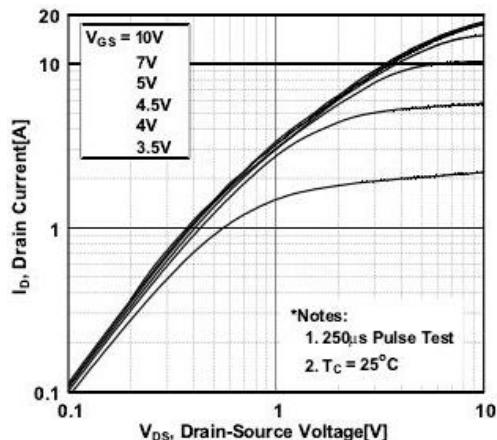


图 1 输出特性曲线,  $T_c = 25^\circ\text{C}$

Fig1 Typical Output Characteristics,  $T_c = 25^\circ\text{C}$

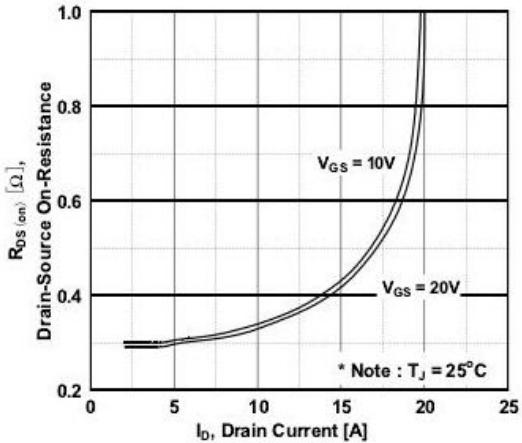


图 2 导通电阻与漏极电流和栅极电压曲线

Fig2 On-Resistance Vs.Drain Current and Gate Voltage

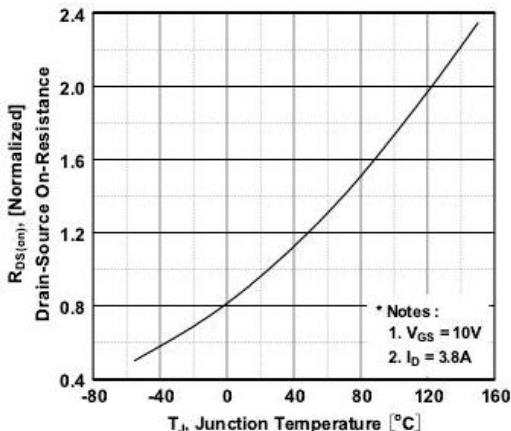


图 3 导通电阻与温度曲线

Fig3 Normalized On-Resistance Vs.Temperature

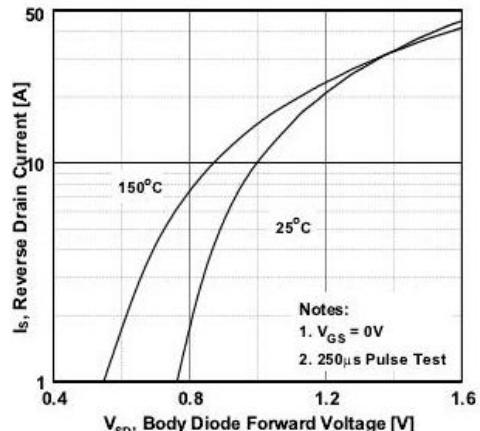


图 4 二极管正向电压曲线

Fig4 Typical Source-Drain Diode Forward Voltage

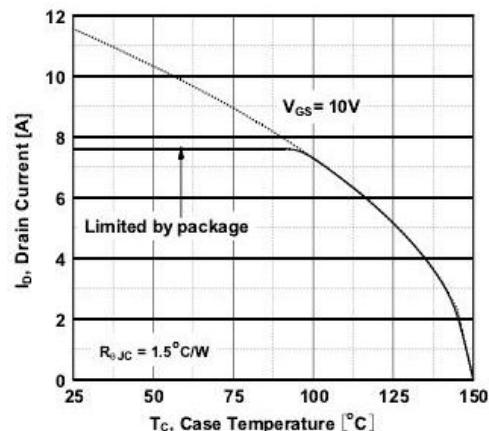


图 5 最大漏极电流与壳温曲线

Fig5 Maximum Drain Current Vs.Case Temperature

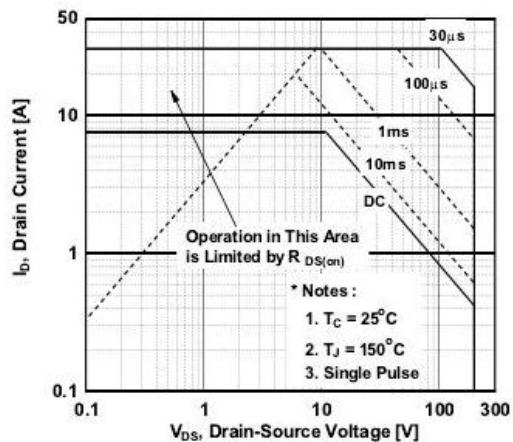


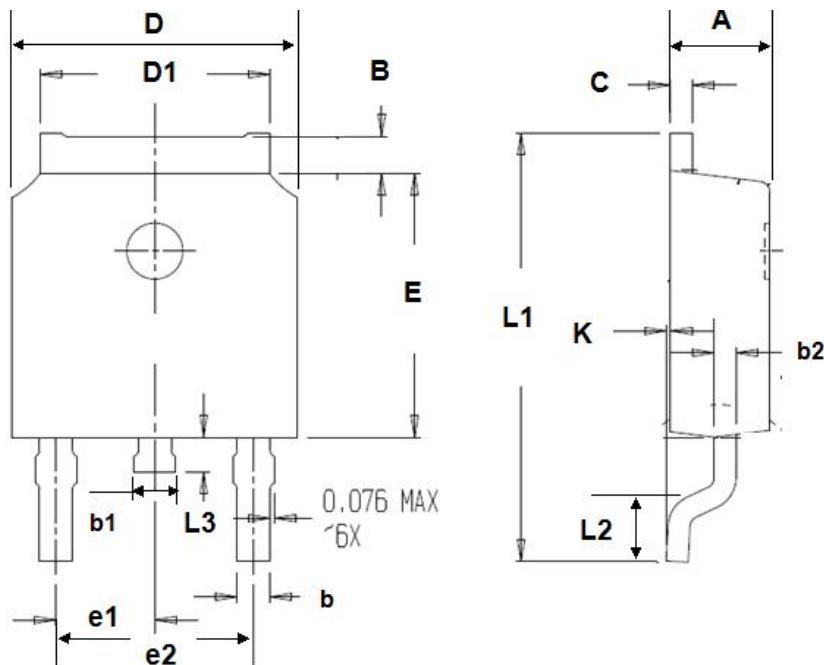
图 6 最大安全工作区曲线

Fig6 Maximum Safe Operating Area

## TO-252 封装机械尺寸 TO-252 MECHANICAL DATA

单位:毫米/UNIT: mm

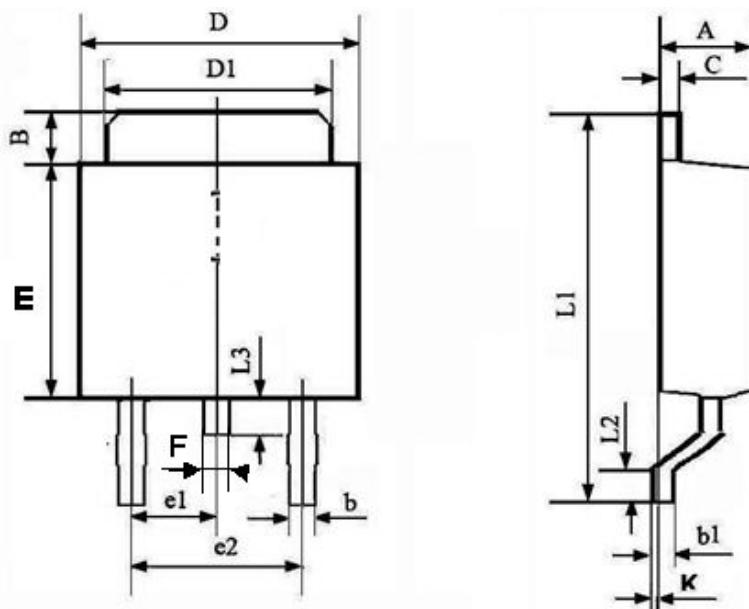
符号 <b>SYMBOL</b>	最小值 <b>min</b>	最大值 <b>max</b>	符号 <b>SYMBOL</b>	最小值 <b>min</b>	最大值 <b>max</b>
A	2.10	2.50	B	0.85	1.25
b	0.50	0.80	b1	0.70	1.20
b2	0.45	0.70	C	0.45	0.70
D	6.30	6.75	D1	5.10	5.50
E	5.30	6.30	e1	2.25	2.35
L1	9.20	10.60	e2	4.45	4.75
L2	0.90	1.75	L3	0.60	1.10
K	0.00	0.23			



## TO-252T 封装机械尺寸 TO-252T MECHANICAL DATA

单位:毫米/UNIT: mm

符号 <b>SYMBOL</b>	最小值 <b>min</b>	最大值 <b>max</b>	符号 <b>SYMBOL</b>	最小值 <b>min</b>	最大值 <b>max</b>
A	2.20	2.40	B	0.85	1.25
b	0.50	0.80	C	0.45	0.70
b1	0.45	0.70	D	6.30	6.70
D1	5.10	5.50	E	5.30	6.20
L1	9.20	10.60	F	0.50	0.90
L2	0.90	1.50	e1	2.25	2.35
L3	0.60	1.10	e2	4.50	4.70
			K	0.00	0.18

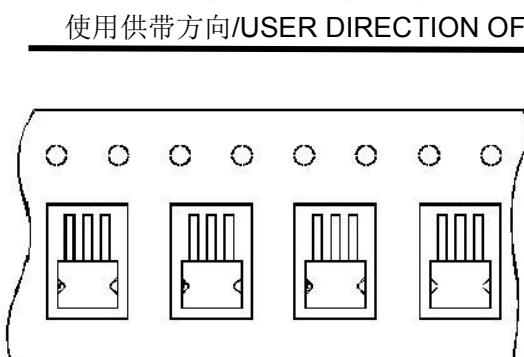
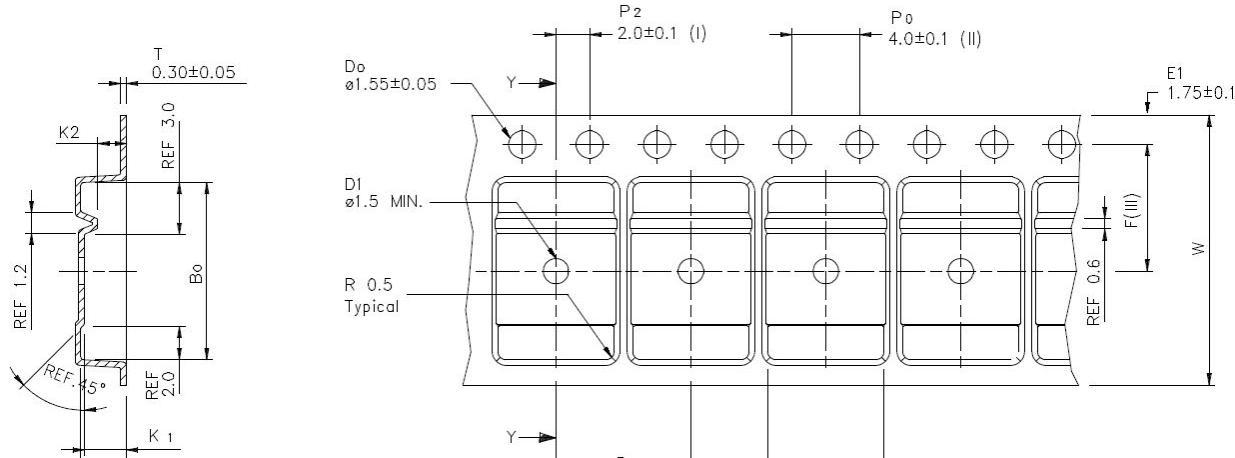


[LJ]

## TO-252 编带规格尺寸 TO-252 TAPE AND REEL DATA

单位:毫米/UNIT: mm

符号 <b>SYMBOL</b>	最小值 <b>min</b>	典型值 <b>nom</b>	最大值 <b>max</b>	符号 <b>SYMBOL</b>	最小值 <b>min</b>	典型值 <b>nom</b>	最大值 <b>max</b>
A <sub>0</sub>	6.80	6.90	7.00	B <sub>0</sub>	10.40	10.50	10.60
K <sub>0</sub>	2.60	2.70	2.90	K <sub>1</sub>	2.40	2.50	2.60
F	7.40	7.50	7.60	K <sub>2</sub>	1.60	1.70	1.80
W	15.90	16.00	16.10	P <sub>1</sub>	7.90	8.00	8.10



编带器件定位/UNIT ORIENTATION